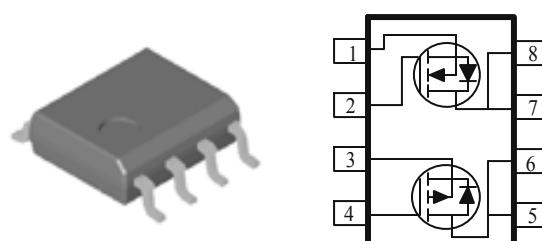


P & N-Channel 32-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low $r_{DS(on)}$ provides higher efficiency and extends battery life
- Low thermal impedance copper leadframe SOIC-8 saves board space
- Fast switching speed
- High performance trench technology

PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ m(Ω)	I_D (A)
30	82 @ $V_{GS} = 4.5V$	4.2
	50 @ $V_{GS} = 10V$	5.3
-30	80 @ $V_{GS} = -4.5V$	-4.2
	52 @ $V_{GS} = -10V$	-5.2



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ UNLESS OTHERWISE NOTED)				
Parameter	Symbol	N-Channel	P-Channel	Units
Drain-Source Voltage	V_{DS}	30	-30	V
Gate-Source Voltage	V_{GS}	± 20	± 20	
Continuous Drain Current ^a	$T_A=25^\circ C$	I_D	5.3	A
	$T_A=70^\circ C$		4.2	
Pulsed Drain Current ^b	I_{DM}	20	-20	
Continuous Source Current (Diode Conduction) ^a	I_S	1.3	-1.3	A
Power Dissipation ^a	$T_A=25^\circ C$	P_D	2.1	W
	$T_A=70^\circ C$		1.3	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Maximum	Units	
Maximum Junction-to-Ambient ^a	$R_{\theta JA}$	62.5	°C/W	
Steady-State		110	°C/W	

Notes

- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

SPECIFICATIONS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Conditions	Limits			
			Ch	Min	Typ	Max
Static						
Gate-Threshold Voltage	$V_{GS(\text{th})}$	$V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$	N	1.2	1.7	2.5
		$V_{GS} = V_{DS}, I_D = -250 \mu\text{A}$	P	-1.2	-1.8	-2.5
Gate-Body Leakage	I_{GSS}	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	P	± 80	± 100	
		$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	N	± 80	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$	P	-0.8	-1	
		$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$	N	0.8	1	uA
On-State Drain Current ^A	$I_{D(\text{on})}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	N	20	24	
		$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	P	-20	-24	A
Drain-Source On-Resistance ^A	$r_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}, I_D = 5.3 \text{ A}$	N	43	50	
		$V_{GS} = 4.5 \text{ V}, I_D = 4.2 \text{ A}$		70	82	
		$V_{GS} = -10 \text{ V}, I_D = -5.2 \text{ A}$	P	45	52	mΩ
		$V_{GS} = -4.5 \text{ V}, I_D = -4.2 \text{ A}$		72	80	
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS} = 0 \text{ V}, I_S = 1.3 \text{ A}$	N	0.75		
		$V_{GS} = 0 \text{ V}, I_S = -1.3 \text{ A}$	P	-0.88		V
Dynamic						
Total Gate Charge	Q_g	N-Channel $V_{DS}=15\text{V}, V_{GS}=10\text{V}, I_D=5.3\text{A}$ P-Channel $V_{DS}=-15\text{V}, V_{GS}=-10\text{V}, I_D=-5.2\text{A}$	N	2.2	5	
Gate-Source Charge	Q_{gs}		P	10	20	
Gate-Drain Charge	Q_{gd}		N	0.5	1	nC
Turn-On Delay Time	$t_{d(\text{on})}$		P	2.2	5	
Rise Time	t_r		N	0.8	2	
Turn-Off Delay Time	$t_{d(\text{off})}$		P	1.7	4	
Fall-Time	t_f	N-Chaneel $V_{DD}=15\text{V}, V_{GS}=10\text{V}, I_D=1\text{A}$, $R_{\text{GEN}}=6\Omega$, P-Channel $VDD=-15\text{V}, VGS=-10\text{V}, ID=-1\text{A}$ $R_{\text{GEN}}=6\Omega$	N	8	16	
			P	10	20	
			N	5	10	
			P	2.8	6	nS
			N	23	46	
			P	53.6	108	
			N	3	6	
			P	46	92	

Notes

- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

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Typical Electrical Characteristics (N-Channel)

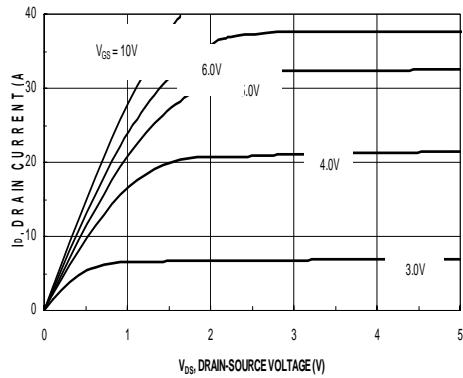


Figure 1. On-Region Characteristics

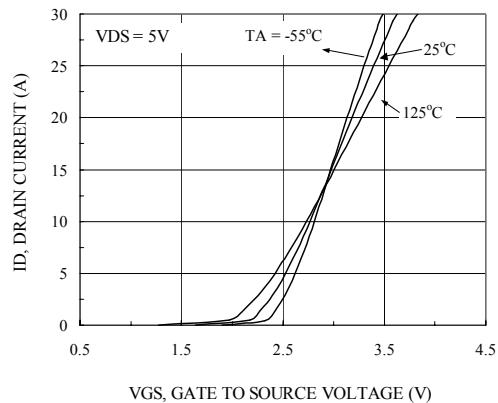


Figure 2. Body Diode Forward Voltage Variation with Source Current and Temperature

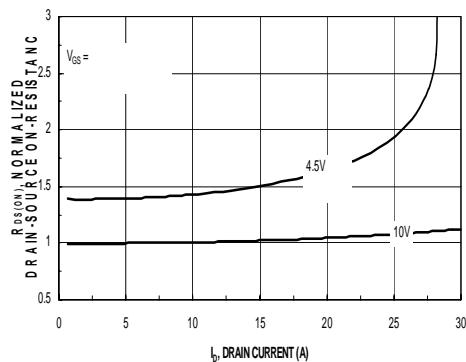


Figure 3. On Resistance Vs Vgs Voltage

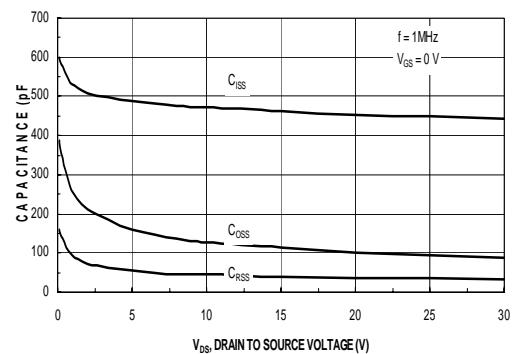


Figure 4. Capacitance Characteristics

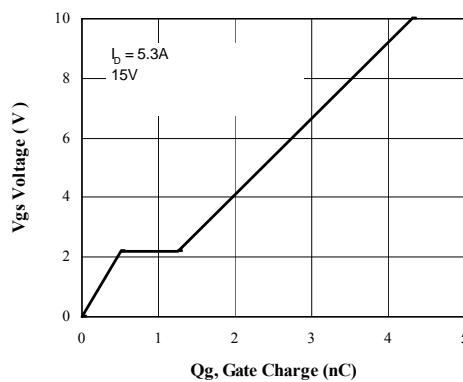


Figure 5. Gate Charge Characteristics

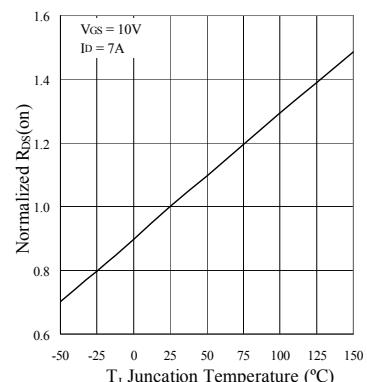


Figure 6. On-Resistance Variation with Temperature

Typical Electrical Characteristics (N-Channel)

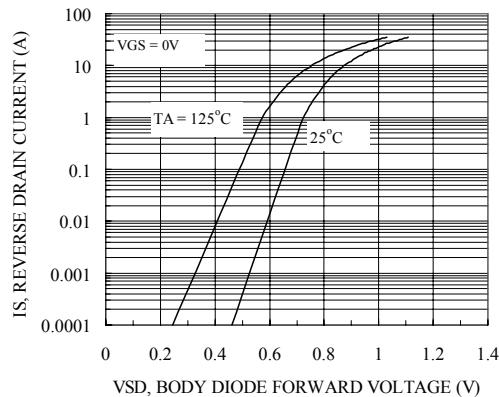


Figure 7. Transfer Characteristics

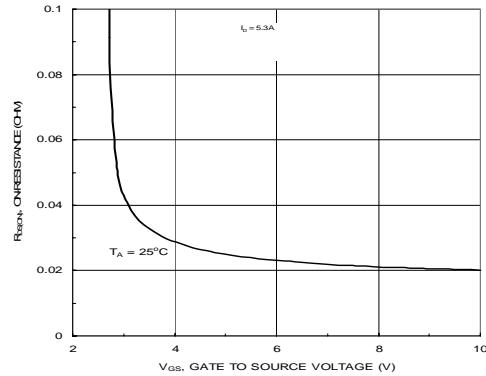


Figure 8. On-Resistance with Gate to Source Voltage

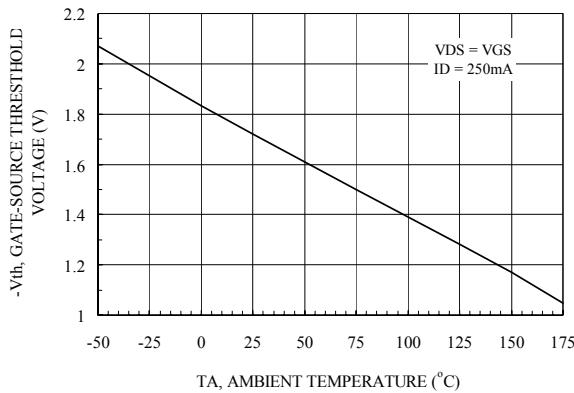
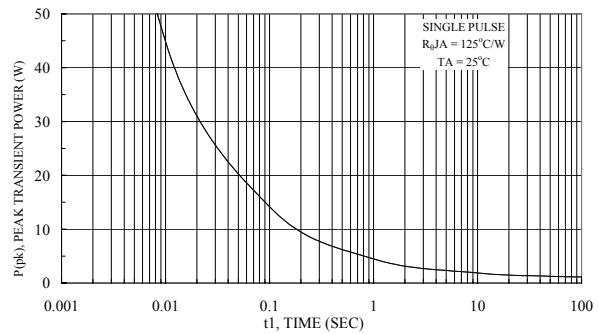
Figure 9. V_{th} Gate to Source Voltage Vs Temperature

Figure 10. Single Pulse Maximum Power Dissipation

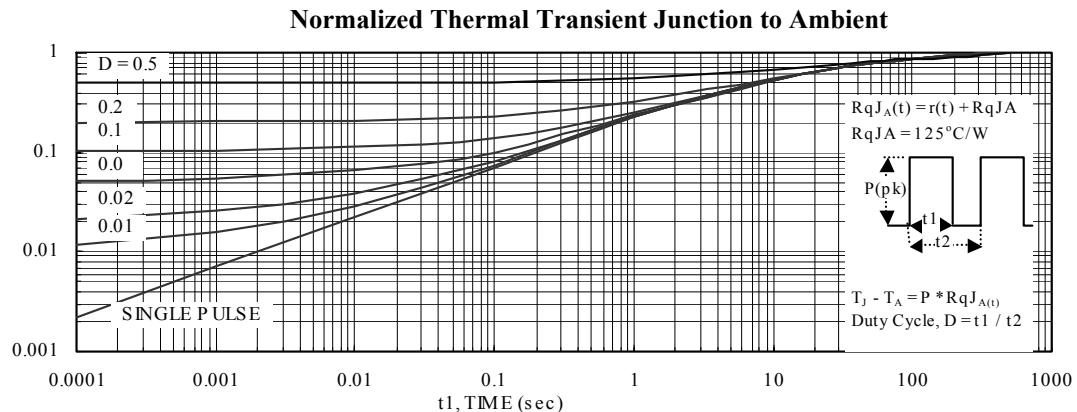


Figure 11. Transient Thermal Response Curve

Typical Electrical Characteristics (P-Channel)

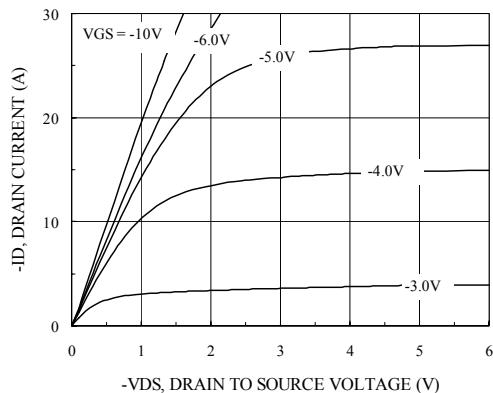


Figure 1. On-Region Characteristics

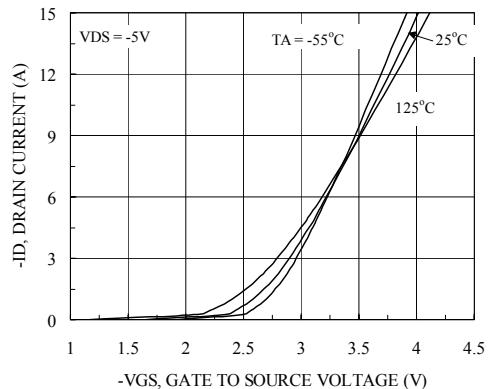


Figure 2. Body Diode Forward Voltage Variation with Source Current and Temperature

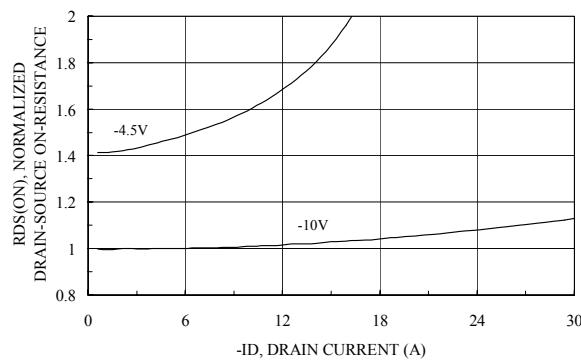


Figure 3. On Resistance Vs Vgs Voltage

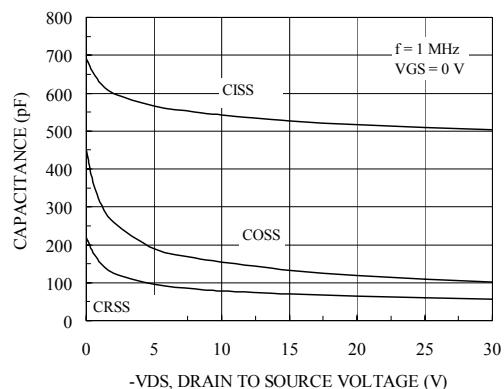


Figure 4. Capacitance Characteristics

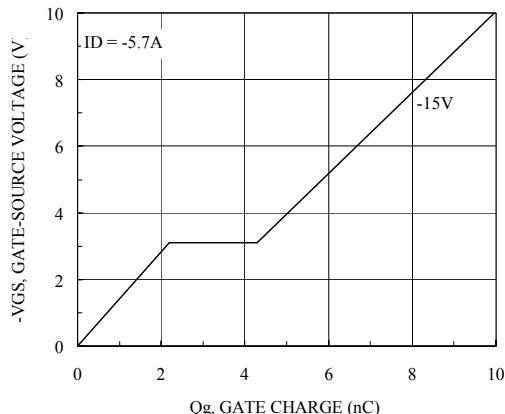


Figure 5. Gate Charge Characteristics

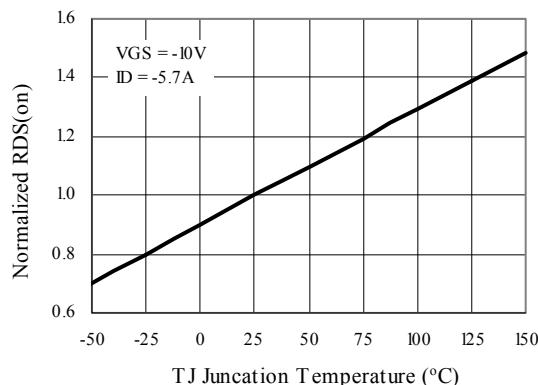


Figure 6. On-Resistance Variation with Temperature

Typical Electrical Characteristics (P-Channel)

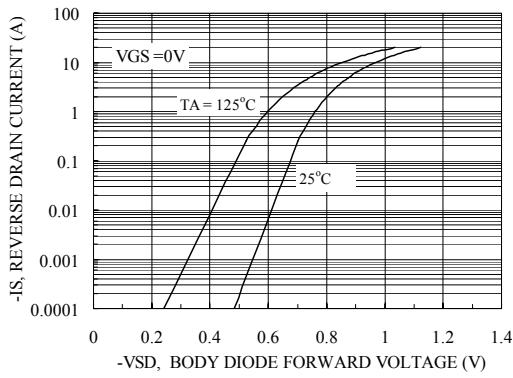


Figure 7. Transfer Characteristics

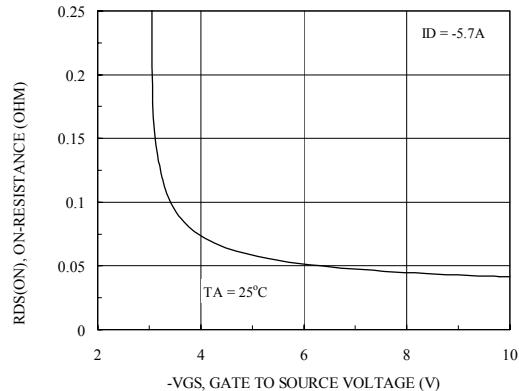


Figure 8. On-Resistance with Gate to Source Voltage

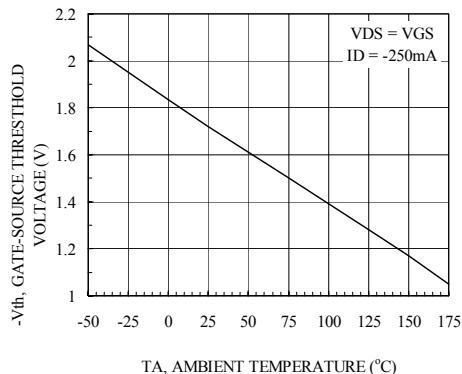
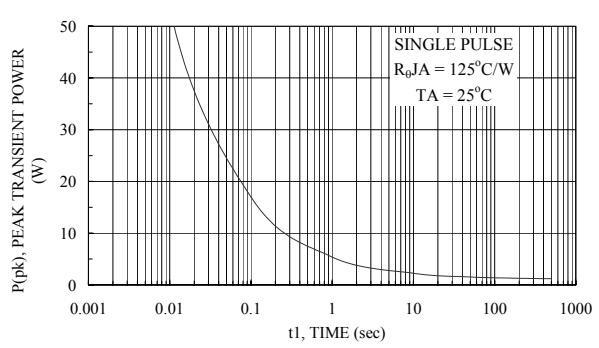
Figure 9. V_{th} Gate to Source Voltage Vs Temperature

Figure 10. Single Pulse Maximum Power Dissipation

Normalized Thermal Transient Junction to Ambient

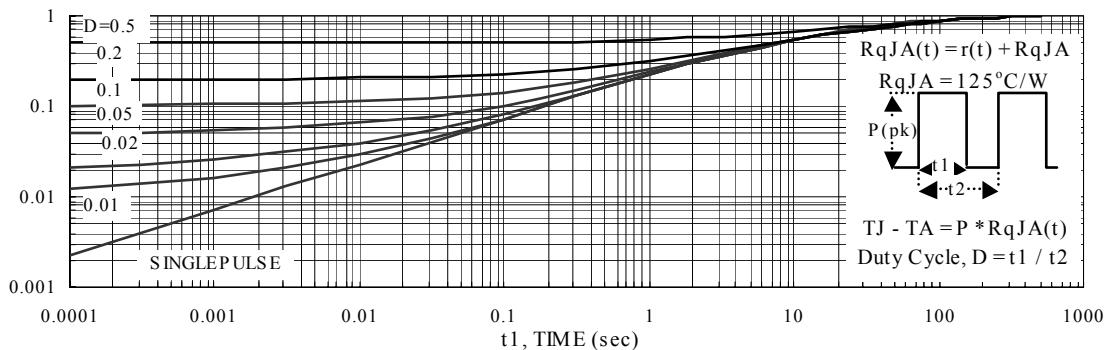
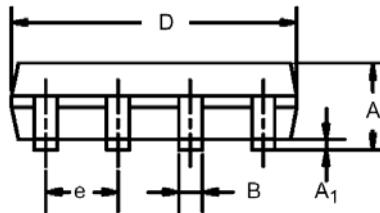
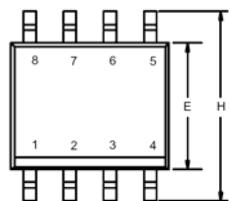


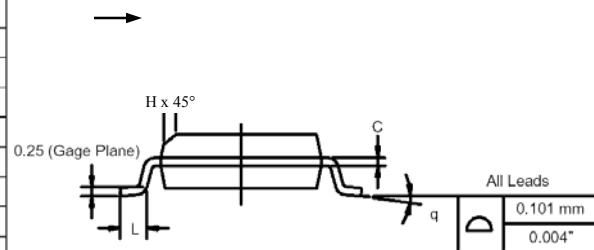
Figure 11. Transient Thermal Response Curve

Package Information

SO-8: 8LEAD



Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A₁	0.10	0.20	0.004	0.008
B	0.35	0.51	0.014	0.020
C	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°



Ordering information

- AM4530C-T1-XX
 - A: Analog Power
 - M: MOSFET
 - 4530: Part number
 - C: Complementary
 - T1: Tape & reel
 - XX: Blank: Standard
PF: Leadfree